

PATENT ASSIGNMENT COVER SHEET

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Assignment ID: PATI463325

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Nataliya Lavrykova-Marrain	03/14/2022
RECEIVING PARTY DATA	
Company Name:	Meso Scale Technologies, LLC.
Street Address:	1601 Research Boulevard
City:	Rockville
State/Country:	MARYLAND
Postal Code:	20850
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17534773
CORRESPONDENCE DATA	
Fax Number:	5167424366
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	5167424343
Email:	tmoran@ssmp.com
Correspondent Name:	Peter I. Bernstein
Address Line 1:	400 GARDEN CITY PLAZA
Address Line 2:	Suite 300
Address Line 4:	Garden City, NEW YORK 11530
ATTORNEY DOCKET NUMBER:	38042
NAME OF SUBMITTER:	TIFFANI MORAN
SIGNATURE:	TIFFANI MORAN
DATE SIGNED:	08/29/2024
Total Attachments: 2	
source=38042_Assignment_Lavrykova-Marrain#page1.tiff	
source=38042_Assignment_Lavrykova-Marrain#page2.tiff	

ASSIGNMENT

WHEREAS, I, as below named inventor, (1) **Nataliya Lavrykova-Marrain** residing at 21611 Stableview Drive, Gaithersburg, MD 20882, a citizen of the United States of America, is an inventor of

PACKAGING FOR PLATES

for **U.S. Application No. 17/534,773** filed on **November 24, 2021**, which claims priority of **U.S. Provisional Application No. 63/118,155**, filed **November 25, 2020**,

AND WHEREAS, Meso Scale Technologies, LLC., a Delaware limited liability company with offices at **1601 Research Boulevard, Rockville, MD 20850, USA** (hereinafter referenced as ASSIGNEE) is desirous of acquiring all, interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefrom in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a solo or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions, continuations, continuations-in-part, substitutes, renewal and reissue thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing continuations, continuations-in-part and subdivisions of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

This assignment executed on the dates indicated below.

EXECUTED THIS 14 day of March 2022


Nataliya Lavrykova-Marrain